The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS products have been discontinued, or will be discontinued soon. Please check the products status on the Hirose website RoHS search at www.hirose-connectors.com, or contact your Hirose sales representative.

0.5mm Pitch SMT Board to Board Connector

DF16 Series





Features

1. Miniaturizing and Slimming

In addition to 0.5mm pitch miniaturization, board to stacking height of 2mm and 2.5mm are prrovided.



Receptacle commonly uses DF16#-*DS-0.5V.

Header Product Name	Stacking Height
DF16#(2.0)-*DP-0.5V	2.0mm
DF16#(2.5)-*DP-0.5V	2.5mm

Note1: The stacking height doesn't include the solder paste thickness.

2. High Contact Reliability

The bellows female contact has a sufficient spring characteristic despite the low profile, and achieves high contact reliability.

3. Click Sensitivity in Mating

The click feeling is considered to facilitate insertion check when the connector is mated.

4. Metal Fitting Available

The metal fitting to prevent the solder peel is provided, considering the mounting on FPC.

5. Corresponding to Automatic Mounting

The connector has the vacuum pick-up area, and enables the automatic mounting with the embossed tape packaging. Connector specification with no boss and no fitting is also.

Applications

Mobile phone, LCD(Liquid Crystal Display), and so on

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■Product Specifications

Doting	Current rating : 0.3A	Operating Temperature Range : -35 to +85°C (Note 1)	Storage Temperature Range : -10 to +60°C (Note 2)
Rating	Voltage rating : 50V AC	Operating Humidity Range : 40 to 80%	Storage Humidity Range : 40 to 70% (Note 2)

Item	Specification	Condition
1. Insulation Resistance	500M ohms min	100V DC
2. Withstanding voltage	No flashover or insulation breakdown.	150V AC/1 minute
3. Contact Resistance	50m ohms max	100mA
4. Vibration	No electrical discontinuity of 1μ s or more	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours in each of the 3 directions.
5. Humidity (Steady state)	Contact resistance: 50m ohms max.Insulation resistance:250M ohms min.	96 hours at temperature of $40^\circ\!C$ and humidity of 90% to 95%
6. Temperature Cycle	Contact resistance: 50m ohms max.:Insulation resistance: 500M ohms min.	(-55℃: 30 minutes 5 to 35℃: 10 minutes
		85℃: 30 minutes 5 to 35℃: 10 minutes) 5 cycles
7. Durability (Mating/un-mating)	Contact resistance: 50m ohms max	50cycle
9 Desistance to Soldering heat	No deformation of components offecting performance	Reflow: At the recommended temperature profile
8. Resistance to Soldering heat	No deformation of components affecting performance.	Manual soldering: 350°C for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non conducting condition of installed connectors in storage, shipment or during transportation.

Note 3: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Material

Product	Part	Material	Treatment	UL Standard
Insulator		Polyamide	White Beige (Natural)	UL94V-0
Receptacle	Contact	Phosphor copper	Gold plated	
	Metal fitting	Brass	Tin plated	
	Insulator	Polyamide	White Beige (Natural)	UL94V-0
Header	Contact	Phosphor copper	Gold plated	
	Metal fitting	Brass	Tin plated	

Ordering Information

Receptacle/Header

$\frac{\mathsf{DF16}}{\bullet} \quad \frac{\#}{\bullet} \frac{(**)}{\bullet} - \frac{*}{\bullet} \frac{\mathsf{DS}}{\bullet} - \frac{0.5}{\bullet} \frac{\mathsf{V}}{\bullet} \frac{(**)}{\bullet}$

1 Se	Series Name : DF16		6	Product height	Contact Pitch			
2 Ty	rpe			Receptacle : None	: 0.5mm			
		Fitting	Boss	Header : 2.0, 2.5	O Contact Type			
	Blank	0	0	4 Number of Contacts	V : Straight SMT			
	В	\bigcirc	X	14, 16, 20, 30, 34, 40, 50, 60, 8	8 Pakaging Type			
		Ŭ		(Note1)	(86) : Gold plating, embossed tape packaging			
				Connector Type				
		DS : Doubl		DS : Double-row receptacle				
				DP : Double-row header				

Note1: For the 14, 16 and 80 contacts connector, the stacking height 2.0mm product only is available.

For the 34 contacts connectors, the stacking height of 2.5mm product only is available.

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Receptacle With metal fitting









[Specific No.] -* *, (* *) (86) :Gold plated, embossed tape packaging

•Receptacle with metal fitting, with boss

Receptacle with metal fitting, with boss Unit: mm										
Part Number	CL No.	Number of Contacts	А	В	С	D	Е	F	G	RoHS
DF16-14DS-0.5V(86)	679-0010-1-86	14	9.0	6.8	3.0	8.8	7.8	6.4	5.0	
DF16-16DS-0.5V(86)	679-0001-0-86	16	9.5	7.3	3.5	9.3	8.3	6.9	5.5	
DF16-20DS-0.5V(86)	679-0002-3-86	20	10.5	8.3	4.5	10.3	9.3	7.9	6.5	
DF16-30DS-0.5V(86)	679-0003-6-86	30	13.0	10.8	7.0	12.8	11.8	10.4	9.0	
DF16-34DS-0.5V(86)	679-0009-2-86	34	14.0	11.8	8.0	13.8	12.8	11.4	10.0	YES
DF16-40DS-0.5V(86)	679-0004-9-86	40	15.5	13.3	9.5	15.3	14.3	12.9	11.5	
DF16-50DS-0.5V(86)	679-0005-1-86	50	18.0	15.8	12.0	17.8	16.8	15.4	14.0	
DF16-60DS-0.5V(86)	679-0006-4-86	60	20.5	18.3	14.5	20.3	19.3	17.9	16.5	
DF16-80DS-0.5V(86)	679-0008-0-86	80	25.5	23.3	19.5	25.3	24.3	22.9	21.5	

•Receptacle with metal fitting, without boss

Receptacle with metal fitting, without boss Unit: mm										
Part Number	CL No.	Number of Contacts	А	В	С	D	Е	F	G	RoHS
DF16B-14DS-0.5V(86)	679-0030-9-86	14	9.0	6.8	3.0	8.8	7.8	6.4		
DF16B-16DS-0.5V(86)	679-0021-8-86	16	9.5	7.3	3.5	9.3	8.3	6.9		
DF16B-20DS-0.5V(86)	679-0022-0-86	20	10.5	8.3	4.5	10.3	9.3	7.9		
DF16B-30DS-0.5V(86)	679-0023-3-86	30	13.0	10.8	7.0	12.8	11.8	10.4		
DF16B-34DS-0.5V(86)	679-0029-0-86	34	14.0	11.8	8.0	13.8	12.8	11.4		YES
DF16B-40DS-0.5V(86)	679-0024-6-86	40	15.5	13.3	9.5	15.3	14.3	12.9		
DF16B-50DS-0.5V(86)	679-0025-9-86	50	18.0	15.8	12.0	17.8	16.8	15.4		
DF16B-60DS-0.5V(86)	679-0026-1-86	60	20.5	18.3	14.5	20.3	19.3	17.9		
DF16B-80DS-0.5V(86)	679-0028-7-86	80	25.5	23.3	19.5	25.3	24.3	22.9		

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Board to Board 2mm Header With metal fitting







[Specific No.] -* *, (* *) (86) :Gold plated, embossed tape packaging

Board to Board 2mm Header with metal fitting, with boss

3,								01110.11111
Part Number	CL No.	Number of Contacts	А	В	С	D	E	RoHS
DF16(2.0)-14DP-0.5V(86)	679-0049-7-86	14	6.7	3.0	6.5	5.3	4.4	
DF16(2.0)-16DP-0.5V(86)	679-0041-5-86	16	7.2	3.5	7.0	5.8	4.9	
DF16(2.0)-20DP-0.5V(86)	679-0042-8-86	20	8.2	4.5	8.0	6.8	5.9	
DF16(2.0)-30DP-0.5V(86)	679-0043-0-86	30	10.7	7.0	10.5	9.3	8.4	YES
DF16(2.0)-40DP-0.5V(86)	679-0044-3-86	40	13.2	9.5	13.0	11.8	10.9	TES
DF16(2.0)-50DP-0.5V(86)	679-0045-6-86	50	15.7	12.0	15.5	14.3	13.4	
DF16(2.0)-60DP-0.5V(86)	679-0046-9-86	60	18.2	14.5	18.0	16.8	15.9	
DF16(2.0)-80DP-0.5V(86)	679-0048-4-86	80	23.2	19.5	23.0	21.8	20.9	

Board to Board 2mm Header with metal fitting, without boss

Board to Board 2mm Header with metal fitting, without boss								
Part Number	CL No.	Number of Contacts	А	В	С	D	E	RoHS
DF16B(2.0)-14DP-0.5V(86)	679-0069-4-86	14	6.7	3.0	6.5	5.3		
DF16B(2.0)-16DP-0.5V(86)	679-0061-2-86	16	7.2	3.5	7.0	5.8		
DF16B(2.0)-20DP-0.5V(86)	679-0062-5-86	20	8.2	4.5	8.0	6.8		
DF16B(2.0)-30DP-0.5V(86)	679-0063-8-86	30	10.7	7.0	10.5	9.3		YES
DF16B(2.0)-40DP-0.5V(86)	679-0064-0-86	40	13.2	9.5	13.0	11.8		TES
DF16B(2.0)-50DP-0.5V(86)	679-0065-3-86	50	15.7	12.0	15.5	14.3		
DF16B(2.0)-60DP-0.5V(86)	679-0066-6-86	60	18.2	14.5	18.0	16.8		
DF16B(2.0)-80DP-0.5V(86)	679-0068-1-86	80	23.2	19.5	23.0	21.8		

Unit: mm

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Board to Board 2.5mm Header With metal fitting





[Specific No.] -* *, (* *) (86) :Gold plated, embossed tape packaging

•Board to Board 2.5mm Header with metal fitting, with boss

g,								
Part Number	CL No.	Number of Contacts	А	В	С	D	E	RoHS
DF16(2.5)-20DP-0.5V(86)	679-0082-2-86	20	8.2	4.5	8.0	6.8	5.9	
DF16(2.5)-30DP-0.5V(86)	679-0083-5-86	30	10.7	7.0	10.5	9.3	8.4	
DF16(2.5)-34DP-0.5V(86)	679-0089-1-86	34	11.7	8.0	11.5	10.3	9.4	YES
DF16(2.5)-40DP-0.5V(86)	679-0084-8-86	40	13.2	9.5	13.0	11.8	10.9	TES
DF16(2.5)-50DP-0.5V(86)	679-0085-0-86	50	15.7	12.0	15.5	14.3	13.4	
DF16(2.5)-60DP-0.5V(86)	679-0086-3-86	60	18.2	14.5	18.0	16.8	15.9	

•Board to Board 2.5mm Header with metal fitting, without boss

Part Number	CL No.	Number of Contacts	А	В	С	D	Е	RoHS
DF16B(2.5)-20DP-0.5V(86)	679-0102-8-86	20	8.2	4.5	8.0	6.8		
DF16B(2.5)-30DP-0.5V(86)	679-0103-0-86	30	10.7	7.0	10.5	9.3	—	
DF16B(2.5)-34DP-0.5V(86)	679-0109-7-86	34	11.7	8.0	11.5	10.3	—	YES
DF16B(2.5)-40DP-0.5V(86)	679-0104-3-86	40	13.2	9.5	13.0	11.8		TEO
DF16B(2.5)-50DP-0.5V(86)	679-0105-6-86	50	15.7	12.0	15.5	14.3		
DF16B(2.5)-60DP-0.5V(86)	679-0106-9-86	60	18.2	14.5	18.0	16.8		

Unit: mm

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Recommended PCB mounting pattern

Receptacle



Note1: If the pattern is included in the shaded area, and is not treated with resist, it could touch the connector contact.

Number of Contacts	С	G	М	Ν
14	3.0	5.0	9.4	5.8
16	3.5	5.5	9.9	6.3
20	4.5	6.5	10.9	7.3
30	7.0	9.0	13.4	9.8
34	8.0	10.0	14.4	10.8
40	9.5	11.5	15.9	12.3
50	12.0	14.0	18.4	14.8
60	14.5	16.5	20.9	17.3
80	19.5	21.5	25.9	22.3

Note2: If the boss isn't included, the boss hole shown in the above isn't required.

•Header (Board to Board 2.0, 2.5mm)



Note1: If the pattern is included in the shaded area, and is not treated with resist, it could touch the connector contact.

Note2: If the boss isn't included, the boss hole shown in the above isn't required.

Note3: Don't install any part in the shaded area. If installed, the connectors can't be mated with each other.

Number of Contacts	В	E	G	Н	К
14	3.0	4.4	7.4	5.4	9.0
16	3.5	4.9	7.9	5.9	9.5
20	4.5	5.9	8.9	6.9	10.5
30	7.0	8.4	11.4	9.4	13.0
34	8.0	9.4	12.4	10.4	14.0
40	9.5	10.9	13.9	11.9	15.5
50	12.0	13.4	16.4	14.4	18.0
60	14.5	15.9	18.9	16.9	20.5
80	19.5	20.9	23.9	21.9	25.5

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Embossed Carrier Tape Dimensions

Receptacle







Reel Dimensions

Reel Dimensions









Product Name	Ν	М	L	Q
DF16#-14DS-0.5V	24.0	_	11.5	24.4
DF16#-16DS-0.5V	24.0		11.5	24.4
DF16#-20DS-0.5V	24.0		11.5	24.4
DF16#-30DS-0.5V	24.0		11.5	24.4
DF16#-34DS-0.5V	24.0		11.5	24.4
DF16#-40DS-0.5V	32.0	28.4	14.2	32.4
DF16#-50DS-0.5V	32.0	28.4	14.2	32.4
DF16#-60DS-0.5V	32.0	28.4	14.2	32.4
DF16#-80DS-0.5V	44.0	40.4	20.2	44.4
DF16#(2.0)-14DP-0.5V	16.0		7.5	16.4
DF16#(2.0)-16DP-0.5V	16.0		7.5	16.4
DF16#(2.0)-34DP-0.5V	24.0		11.5	24.4
DF16#(2.0/2.5)-20DP-0.5V	16.0		7.5	16.4
DF16#(2.0/2.5)-30DP-0.5V	24.0		11.5	24.4
DF16#(2.0/2.5)-40DP-0.5V	24.0		11.5	24.4
DF16#(2.0/2.5)-50DP-0.5V	24.0		11.5	24.4
DF16#(2.0/2.5)-60DP-0.5V	32.0	28.4	14.2	32.4
DF16#(2.0/2.5)-80DP-0.5V	44.0	40.4	20.2	44.4

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Precautions

1 Decommended Temperature Drefile (CMT)							
1. Recommended Temperature Profile (SMT)	Temperatur	re (°C)					
	250	250°C					
	200	-		220°C	<u>60s</u>	ec max Idering	
	150	- 150°C -					
	100		<u>90~12</u> Prehe		-		
	50 Room temperature	/					
	0	50	100	150	200	250 Time (see	300 c.)
	Note1: Up to 2 cycles of Reflow soldering are possible under the same conditions, provided that						
			are poss	sible und	er the s	ame condi	itions, provided that
	there is a return to norm	-					
	there is a return to norm Note2: The temperature profile	al temperati	ure betwe	een the fi	rst and	second cyc	cle.
		al temperati e indicates t	ure betwe	een the fi	rst and	second cyc	cle.
	Note2: The temperature profile	nal temperati e indicates ti inals.	ure betwe	een the fi	rst and	second cyc	cle.
2. Recommended Manual Soldering Condition (SMT)	Note2: The temperature profile with the connector termi Note3: Environment for header	nal temperatu e indicates ti inals. is room air o	ure between the board bo	een the fi I surface	rst and s	second cyc	cle.
 Recommended Manual Soldering Condition (SMT) Recommended Screen Thickness (SMT) 	Note2: The temperature profile with the connector term Note3: Environment for header Soldering iron temperature: 350	nal temperatu e indicates ti inals. is room air o	ure between the board bo	een the fi I surface	rst and s	second cyc	cle.
	Note2: The temperature profile with the connector term Note3: Environment for header Soldering iron temperature: 350	nal temperatu e indicates th inals. is room air o D, Soldering	ure between he board only. time: Wit	een the fi I surface thin 3 sec	rst and s temper	second cyc	cle.
3. Recommended Screen Thickness (SMT)	Note2: The temperature profile with the connector term Note3: Environment for header Soldering iron temperature: 350 0.15mm	aal temperatu e indicates ti inals. is room air o 0, Soldering ector center a	ure between the board bonly. time: Wite area, base	een the fi I surface thin 3 sec	rst and s temper	second cyc	cle.
 Recommended Screen Thickness (SMT) Board Warp (SMT) 	Note2: The temperature profile with the connector termi Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the conne	aal temperatu e indicates th inals. is room air o D, Soldering ector center a Use Hand bo	ure between the board bonly. time: Witt area, base book".	een the fi I surface thin 3 sec	temper conds e both c	second cyc ature at th	cle. The point of contacts
 Recommended Screen Thickness (SMT) Board Warp (SMT) Cleaning Condition 	Note2: The temperature profile with the connector termi Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the conne Refer to the "Nylon Connector	aal temperatu e indicates th inals. is room air o D, Soldering ector center a Use Hand bo structure wh	ure between the board bonly. time: Witt area, bas book".	een the fi I surface thin 3 sec sed on th acts are	rst and s temper conds e both c exposed	second cyc ature at th	cle. The point of contacts
 Recommended Screen Thickness (SMT) Board Warp (SMT) Cleaning Condition 	Note2: The temperature profile with the connector termi Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the conne Refer to the "Nylon Connector I The header is designed in a	aal temperatu e indicates ti inals. is room air o 0, Soldering ector center a Use Hand bo structure wh r electrostati	ure between the board bonly. time: Wite area, base book". here conte con	een the fi I surface thin 3 sec sed on th acts are at damag	rst and s temper conds e both c exposed e.	second cyc ature at th onnector e	cle. The point of contacts dges g it with bare hands
 Recommended Screen Thickness (SMT) Board Warp (SMT) Cleaning Condition 	 Note2: The temperature profile with the connector termine with the connector termine Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the connector of Refer to the "Nylon Connector of The header is designed in a would cause contact failure or the second se	aal temperatu e indicates t inals. is room air o D, Soldering ector center a Use Hand bo structure wh r electrostati e insertion or o	ure between the board bonly. time: Witt area, base book". there contraction celement celement celement bookstraction	een the fi I surface thin 3 sec sed on th acts are at damag	conds e both c exposed e. e damag	second cyc ature at th onnector e I. Touching e or contact	cle. The point of contacts dges g it with bare hands t deformation.
 Recommended Screen Thickness (SMT) Board Warp (SMT) Cleaning Condition 	Note2: The temperature profile with the connector termi Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the connector Refer to the "Nylon Connector The header is designed in a would cause contact failure o Where no board is mounted, the	al temperature e indicates the inals. is room air of 0, Soldering ector center a Use Hand bo structure whe r electrostati e insertion or of e connector o	ure between the board only. time: Wite area, base ook". there contended to contended to the	een the fi I surface thin 3 sec sed on th acts are nt damag will cause x the boar	rst and s temper conds e both c exposed e. e damag rd by any	second cyc ature at th onnector e I. Touching e or contact	cle. The point of contacts dges g it with bare hands t deformation.
 Recommended Screen Thickness (SMT) Board Warp (SMT) Cleaning Condition 	Note2: The temperature profile with the connector termi Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the conne Refer to the "Nylon Connector The header is designed in a would cause contact failure o Where no board is mounted, the Avoid retaining the board with the	aal temperatu e indicates the inals. is room air of 0, Soldering ector center a Use Hand bo structure whe r electrostati e insertion or of e connector of extraction m	ure between the board only. time: With area, base book". area cont c elemen extraction nly, and fi ay result	een the fi I surface thin 3 sec sed on th acts are nt damag will cause x the boar	rst and s temper conds e both c exposed e. e damag rd by any ge.	second cyc ature at th onnector e I. Touching e or contact other mear	cle. The point of contacts dges g it with bare hands t deformation. The connector.
 Recommended Screen Thickness (SMT) Board Warp (SMT) Cleaning Condition 	Note2: The temperature profile with the connector termi Note3: Environment for header Soldering iron temperature: 350 0.15mm Maximum 0.02mm in the conne Refer to the "Nylon Connector The header is designed in a would cause contact failure o Where no board is mounted, the Avoid retaining the board with the Excessive scoop insertion or	al temperature e indicates the inals. is room air of D, Soldering ector center a Use Hand boo structure when r electrostation e connector of extraction main don't carry of	ure between the board bonly. time: Wite area, base book". there contended to book the co	een the fi I surface thin 3 sec sed on th acts are at damag will cause x the boar in dama	rst and s temper conds e both c exposed e. e damag rd by any ge. n will cau	second cyc ature at th onnector e I. Touching e or contact other mear se a flux blis	cle. The point of contacts dges g it with bare hands t deformation. It deformation. It han the connector. Ster on the connector.